FORM PTO - 1449

INFORMATION DISCLOSURE STATEMENT

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ATTY DOCKET NO.: ASC-022CPC1

APPLICANT: Wu et al.

SERIAL NO.: 10/603,852

FILING DATE: June 25, 2003

EXAMINER: Owens, Douglas W.

GROUP: 2811

U.S. PATENT DOCUMENTS

EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME		CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
Q)40	A70	2001/0003364	06/14/2001	Sugawara et	al.			
	A71	2001/0007789	07/12/2001	Aspar et al.				
	A72	2002/0043660	04/18/2002	Yamazaki et	al.			
	A73	2002/0084000	07/04/2002	Fitzgerald				
	A74	2002/0096717	07/25/2002	Chu et al.				
	A75	2002/0100942	08/01/2002	Fitzgerald et	al.		-	
	A76	2002/0123167	09/05/2002	Fitzgerald		-		
	A77	2002/0123183	09/05/2002	Fitzgerald				
	A78	2002/0125471	09/12/2002	Fitzgerald et	al.			
	A79	2002/0168864	11/14/2002	Cheng et al.				
	A80	2003/0003679	01/02/2003	Doyle et al.				
	A81	2003/0013305	01/16/2003	Sugii et al.				
	A82	2003/0034529	02/20/2003	Fitzgerald et	al.			
	A83	2003/0057439	03/27/2003	Fitzgerald			 	
	A84	2003/0102498	06/05/2003	Braithwaite 6	et al.			
	A85	2003/0119280	06/26/2003	Lee et al.				12/02/2002
	A86	2003/0127646	07/10/2003	Christiansen	et al.			12/18/2002
	A87	2003/0139000	07/24/2003	Bedell et al.				01/23/2002
	A88	2003/0157787	08/21/2003	Murthy et al.				02/21/2002
	A89	2003/0160300	08/28/2003	Takenaka et	al.			02/24/2003
	A90	2003/0178681	09/25/2003	Clark et al.				04/02/2003
	A91	2003/0189229	10/09/2003	Mouli				04/05/2002
00	A92	2003/0199126	10/23/2003	Chu et al.			 	04/23/2002
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010	A93	2003/0201458	10/30/2003	Clark et al.			05/16/2003
1	A94	2003/0203600	10/30/2003	Chu et al.			06/15/2003
	A95	2003/0207127	11/06/2003	Murthy et al.			05/30/2003
-	A96	2003/0215990	11/20/2003	Fitzgerald et al.			03/14/2003
	A97	2003/0218189	11/27/2003	Christiansen	1		11/19/2002
-	A98	2003/0219957	11/27/2003	Kuwabara et al.			05/29/2003
-	A99	2003/0227036	12/11/2003	Sugiyama et al.			02/21/2003
-	A100	2003/0227057	12/01/2003	Lochtefeld et al.			10/04/2002
	A101	2003/0230778	12/18/2003	Park et al.			01/30/2003
+	A102	2003/0232467	12/18/2003	Anderson et al.		 	05/29/2003
	A103	2004/0005740	01/01/2004	Lochtefeld et al.			06/06/2003
	A104	2004/0007724	01/15/2004	Murthy et al.	1		07/12/2002
_	A105	2004/0009649	01/15/2004	Kub et al.			05/20/2003
	A106	2004/0012037	01/22/2004	Venkatesan et al.			07/18/2002
+	A107	2004/0012075	01/22/2004	Bedell et al.			07/16/2002
-	A108	2004/0014304	01/22/2004	Bhattacharyya	<u> </u>		07/18/2002
	A109	2004/0018699	01/29/2004	Boyd et al.			07/24/2002
	A110	2004/0031979	02/19/2004	Lochtefeld			06/06/2003
+	A111	2004/0031990	02/19/2004	Jin et al.			08/16/2002
+	A112	2004/0041174	03/04/2004	Okihara		1	03/21/2003
+	A113	2004/0041210	03/04/2004	Mouli	-		09/02/2003
-	A114	2004/0048091	03/11/2004	Sato et al.	1.	 	09/04/2003
9119			Sakaguchi	+		09/04/2003	
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INFORM	OITAN	N DISCLOSUR	E STATEM	ENT	APPLICANT: Wu et al.				
					SERIAL NO.: 10/603,852				
					FILING DATE: June 25, 2003				
					EXAMINER: C	wens, Dougl	as W.		
					GROUP: 2811				
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EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME		CLASS	SUB CLASS	FILING DATE IF APPROPRIATE	
R)KI	A116	2004/0051140	03/18/2004	Bhattach	агууа			09/12/2002	
	A117	2004/0053477	03/18/2004	Ghyseler	n et al.			07/09/2003	
	A118	2004/0075149	04/22/2004	Fitzgeral	d et al.			07/23/2003	
	A119	4,704,302	11/03/1987	Bruel et	al.				
	A120	4,710,788	12/01/1987	Dambkes et al.					
1	A121	4,987,462	01/22/1991	Kim et al.					
	A122	4,990,979	02/05/1991	Otto					
	A123	4,997,776	03/05/1991	Harame	et al.				
	A124	5,155,571	10/13/1992	Wang et	al.			·	
	A125	5,177,583	01/05/1993	Endo et	al.				
	A126	5,240,876	08/34/1993	Gaul et a	zl.				
	A127	5,241,197	08/31/1993	Murakar	ni <i>et al</i> .				
	A128	5,250,445	10/05/1993	Bean et	al.				
	A129	5,291,439	03/01/1994	Kauffma	nn et al.				
	A130	5,298,452	03/29/1994	Meyerso	n				
	A131	5,316,958	05/31/1994	Meyerso	n				
	A132	5,399,522	03/21/1995	Ohori					
	A133	5,424,243	06/13/1995	Takasak	i				
·	A134	5,426,069	06/20/1995	Selvaku	mar <i>et al</i> .				
\top	A135	5,426,316	06/20/1995	Mohami	mad				
	A136	5,439,843	08/08/1995	Sakaguc	hi et al.				
	A137	5,461,250	10/24/1995	Burghar	tz et al.				

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Baca et al.

DATE CONSIDERED 12/17/04

FORM I	TO - 1	449			ATTY DOCKET NO.: ASC-022CPC1				
INFORM	1ATIO	N DISCLOSU	RE STATEM	ENT	APPLICANT: Wu et al.				
					SERIAL NO.: 10/603,852				
					FILING DATE: June 25, 2003				
					EXAMINER: O	wens, Dougl	as W.		
					GROUP: 2811				
			U.	S. PATE	NT DOCUMENTS	3			
EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME		CLASS	SUB CLASS	FILING DATE IF APPROPRIATE	
DK9	A139	5,523,243	06/04/1996	Mohamn	nad				
	A140	5,572,043	11/05/1996	Shimizu	et al.				
	A141	5,596,527	01/21/1997	Tomioka	et al.				
	A142	5,617,351	04/01/1997	Bertin et	al.				
	A143	5,630,905	05/20/1997	0/1997 Lynch et al.					
	A144	5,659,187	08/19/1997	9/1997 Legoues et al.					
	A145	5,698,869	12/16/1997	6/1997 Yoshimi <i>et al</i> .					
	A146	5,714,777	02/03/1998	Ismail et	al.				
	A147	5,739,567	04/14/1998	Wong					
	A148	5,777,347	07/07/1998	Bartelinl	C				
	A149	5,786,612	07/28/1998	Otani et	al.				
	A150	5,786,614	07/28/1998	Chuang	et al.				
	A151	5,808,344	09/15/1998	Ismail et	al.				
	A152	5,847,419	12/08/1998	Imai et a	l.				
	A153	5,863,830	01/26/1999	Bruel et	al.				
	A154	5,882,987	03/16/1999	Srikrish	nan				
	A155	5,912,479	06/15/1999	Mori et e	al.				
	A156	5,963,817	10/05/1999	Chu et a	l.				
	A157	5,993,677	11/30/1999	Biasse e	t al.				
	A158	6,013,134	01/11/2000	Chu et a	l.				
	A159	6,013,563	01/11/2000	Henley o	et al.				
	A160	6,020,252	02/01/2000	Aspar et					
QM9	A161	6,058,044	05/02/2000	Sugiura	et al.				

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FORM I	PTO - 1	449			ATTY DOCKET NO.: ASC-022CPC1				
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			U.	S. PATE	NT DOCUMENTS				
EXAM. INIT.	-	DOCUMENT NUMBER	DATE	NAME		CLASS	SUB CLASS	FILING DATE IF APPROPRIATE	
2340	A162	6,103,597	08/15/2000	Aspar et al.					
<u> </u>	A163	6,103,599	08/15/2000	Henley e	t al.				
\dashv	A164	6,130,453	10/10/2000	Mei et a	<u>.</u>				
	A165	6,133,799	10/17/2000	Favors e	t al.				
	A166	6,140,687	10/31/2000	Shimomura et al.					
	A167	6,143,636	11/07/2000	Forbes et al.					
	A168	6,160,303	12/12/2000	Fattaruso					
	A169	6,162,705	12/19/2000	Henley et al.					
	A170	6,190,998 B1	02/20/2001	Bruel et	al.				
	A171	6,204,529	03/20/2001	Lung et	al.				
	A172	6,225,192 B1	05/01/2001	Aspar et	al.				
	A173	6,242,324	06/05/2001	Kub et a	l.				
	A174	6,249,022	06/19/2001	Lin et al		_			
	A175	6,251,751 B1	06/26/2001	Chu et a	l.				
	A176	6,266,278	07/24/2001	Harari e	al.				
	A177	6,271,551	08/07/2001	Schmitz	et al.				
	A178	6,271,726	08/07/2001	Fransis e	et al.				
	A179	6,290,804 B1	09/18/2001	Henley e	et al.				
	A180	6,303,468 B1	10/16/2001	Aspar et	al.				
	A181	6,316,301	11/13/2001	Kant					
	A182	6,326,667 B1	12/04/2001	Sugiyam	na et al.				
1	A183	6,329,063	12/11/2001	Lo et al.					
N19	A184	6,339,232	01/15/2002	Takagi					

DATE CONSIDERED 12/17/04

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INFORMATION DISCLOSURE STATEMENT

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	NUMBER	DATE	NAME		CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
A185	6,344,417 B1	02/05/2002	Usenko				
A186	6,346,459 B1	02/12/2002	Usenko et al	•			
A187	6,352,909	03/05/2002	Usenko				
A188	6,355,493 B1	03/12/2002	Usenko				
A189	6,368,938 B1	04/09/2002	Usenko				
A190	6,369,438 B1	04/09/2002	Sugiyama et	al.			
A191	6,372,593	04/16/2002	Hattori et al				
A192	6,372,609 B1	04/16/2002	Aga et al.				
A193	6,387,829 B1	05/14/2002	Usenko et al	•			
A194	6,391,740 B1	05/21/2002	Cheung et al				
A195	6,399,970	06/04/2002	Kubo et al.	Kubo et al.			
A196	6,403,975	06/11/2002	Brunner et a	1.			
A197	6,407,406	06/18/2002	Tezuka				
A198	6,410,371 B1	06/25/2002	Yu et al.				
A199	6,420,937	07/16/2002	Akatsuka et	al.			
A200	6,425,951	07/30/2002	Chu et al.				
A201	6,429,061	08/06/2002	Rim	:			
A202	6,445,016 B1	09/03/2002	An et al.				
A203	6,448,152 B1	09/10/2002	Henley et al.				
A204	6,455,397 B1	09/24/2002	Belford				
A205	6,458,672 B1	10/01/2002	Henley et al.				
A206	6,475,072 B1	11/05/2002	Canaperi et	al.			
A207	6,514,836 B2	02/04/2003	Belford				
	A186 A187 A188 A189 A190 A191 A192 A193 A194 A195 A196 A197 A198 A199 A200 A201 A202 A203 A204 A205 A206	NUMBER A185 6,344,417 B1 A186 6,346,459 B1 A187 6,352,909 A188 6,355,493 B1 A189 6,368,938 B1 A190 6,369,438 B1 A191 6,372,593 A192 6,372,609 B1 A193 6,387,829 B1 A194 6,391,740 B1 A195 6,399,970 A196 6,403,975 A197 6,407,406 A198 6,410,371 B1 A199 6,420,937 A200 6,425,951 A201 6,429,061 A202 6,445,016 B1 A203 6,448,152 B1 A204 6,455,397 B1 A205 6,458,672 B1 A206 6,475,072 B1	NUMBER NUMBER A185 6,344,417 B1 02/05/2002 A186 6,346,459 B1 02/12/2002 A187 6,352,909 03/05/2002 A188 6,355,493 B1 03/12/2002 A189 6,368,938 B1 04/09/2002 A190 6,369,438 B1 04/09/2002 A191 6,372,593 04/16/2002 A192 6,372,609 B1 04/16/2002 A193 6,387,829 B1 05/14/2002 A194 6,391,740 B1 05/21/2002 A195 6,399,970 06/04/2002 A196 6,403,975 06/11/2002 A197 6,407,406 06/18/2002 A198 6,410,371 B1 06/25/2002 A200 6,425,951 07/30/2002 A201 6,429,061 08/06/2002 A202 6,445,016 B1 09/03/2002 A203 6,448,152 B1 09/10/2002 A204 6,455,397 B1 09/24/2002 A205 6,458,672 B1 10/01/2002 A206 6,475,072 B1 11/05/2002	NUMBER Usenko A185 6,344,417 B1 02/05/2002 Usenko A186 6,346,459 B1 02/12/2002 Usenko et al. A187 6,352,909 03/05/2002 Usenko A188 6,355,493 B1 03/12/2002 Usenko A189 6,368,938 B1 04/09/2002 Usenko A190 6,369,438 B1 04/09/2002 Sugiyama et A191 6,372,593 04/16/2002 Hattori et al. A192 6,372,609 B1 04/16/2002 Aga et al. A193 6,387,829 B1 05/14/2002 Usenko et al. A194 6,391,740 B1 05/21/2002 Cheung et al. A195 6,399,970 06/04/2002 Kubo et al. A196 6,403,975 06/11/2002 Brunner et al. A197 6,407,406 06/18/2002 Tezuka A198 6,410,371 B1 06/25/2002 Yu et al. A200 6,425,951 07/30/2002 Akatsuka et al. A201 6,429,061 08/06/2002 Rim A202 6,445,016 B1 09/03/2002 <td< td=""><td>NUMBER NUMBER A185 6,344,417 B1 02/05/2002 Usenko A186 6,346,459 B1 02/12/2002 Usenko et al. A187 6,352,909 03/05/2002 Usenko A188 6,355,493 B1 03/12/2002 Usenko A190 6,368,938 B1 04/09/2002 Sugiyama et al. A191 6,372,593 04/16/2002 Hattori et al. A192 6,372,609 B1 04/16/2002 Aga et al. A193 6,387,829 B1 05/14/2002 Usenko et al. A194 6,391,740 B1 05/21/2002 Cheung et al. A195 6,399,970 06/04/2002 Kubo et al. A196 6,403,975 06/11/2002 Brunner et al. A197 6,407,406 06/18/2002 Tezuka A198 6,410,371 B1 06/25/2002 Yu et al. A200 6,425,951 07/30/2002 Chu et al. A201 6,425,951 07/30/2002 An et al. A202 6,445,016 B1 09/03/2002 An et al. A203 6,448,152 B1 09/10/2002</td><td>NUMBER NUMBER A185 6,344,417 B1 02/05/2002 Usenko A186 6,346,459 B1 02/12/2002 Usenko et al. A187 6,352,909 03/05/2002 Usenko A188 6,355,493 B1 03/12/2002 Usenko A189 6,368,938 B1 04/09/2002 Usenko A190 6,369,438 B1 04/09/2002 Sugiyama et al. A191 6,372,593 04/16/2002 Aga et al. A192 6,372,609 B1 04/16/2002 Aga et al. A193 6,387,829 B1 05/14/2002 Usenko et al. A194 6,391,740 B1 05/21/2002 Cheung et al. A195 6,399,970 06/04/2002 Kubo et al. A196 6,403,975 06/11/2002 Brunner et al. A197 6,407,406 06/18/2002 Tezuka A198 6,410,371 B1 06/25/2002 Yu et al. A200 6,425,951 07/30/2002 Chu et al. A201 6,429,061 08/06/2002 Rim A202 6,445,016 B1 09/03/2002 An e</td><td>A185 6,344,417 B1 02/05/2002 Usenko A186 6,346,459 B1 02/12/2002 Usenko A187 6,352,909 03/05/2002 Usenko A188 6,355,493 B1 03/12/2002 Usenko A189 6,368,938 B1 04/09/2002 Usenko A190 6,369,438 B1 04/09/2002 Sugiyama et al. A191 6,372,593 04/16/2002 Hattori et al. A192 6,372,609 B1 04/16/2002 Aga et al. A193 6,387,829 B1 05/14/2002 Usenko et al. A194 6,391,740 B1 05/21/2002 Cheung et al. A195 6,399,970 06/04/2002 Kubo et al. A196 6,403,975 06/11/2002 Brunner et al. A197 6,407,406 06/18/2002 Tezuka A198 6,410,371 B1 06/25/2002 Yu et al. A199 6,420,937 07/16/2002 Akatsuka et al. A200 6,425,951 07/30/2002 Chu et al. A201 6,429,061 08/06/2002 Rim A202 6,445,016 B1 09/03/2002 An et al. A203 6,448,152 B1 09/10/2002 Henley et al. A204 6,455,397 B1 09/24/2002 Belford A205 6,458,672 B1 10/01/2002 Canaperi et al.</td></td<>	NUMBER NUMBER A185 6,344,417 B1 02/05/2002 Usenko A186 6,346,459 B1 02/12/2002 Usenko et al. A187 6,352,909 03/05/2002 Usenko A188 6,355,493 B1 03/12/2002 Usenko A190 6,368,938 B1 04/09/2002 Sugiyama et al. A191 6,372,593 04/16/2002 Hattori et al. A192 6,372,609 B1 04/16/2002 Aga et al. A193 6,387,829 B1 05/14/2002 Usenko et al. A194 6,391,740 B1 05/21/2002 Cheung et al. A195 6,399,970 06/04/2002 Kubo et al. A196 6,403,975 06/11/2002 Brunner et al. A197 6,407,406 06/18/2002 Tezuka A198 6,410,371 B1 06/25/2002 Yu et al. A200 6,425,951 07/30/2002 Chu et al. A201 6,425,951 07/30/2002 An et al. A202 6,445,016 B1 09/03/2002 An et al. A203 6,448,152 B1 09/10/2002	NUMBER NUMBER A185 6,344,417 B1 02/05/2002 Usenko A186 6,346,459 B1 02/12/2002 Usenko et al. A187 6,352,909 03/05/2002 Usenko A188 6,355,493 B1 03/12/2002 Usenko A189 6,368,938 B1 04/09/2002 Usenko A190 6,369,438 B1 04/09/2002 Sugiyama et al. A191 6,372,593 04/16/2002 Aga et al. A192 6,372,609 B1 04/16/2002 Aga et al. A193 6,387,829 B1 05/14/2002 Usenko et al. A194 6,391,740 B1 05/21/2002 Cheung et al. 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A204 6,455,397 B1 09/24/2002 Belford A205 6,458,672 B1 10/01/2002 Canaperi et al.

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FORM	PTO - 1	449			ATTY DOCKET	NO.: ASC	-022CPC1		
INFOR	MATIO	N DISCLOSUR	RE STATEM	ENT	APPLICANT: Wu et al.				
					SERIAL NO.: 10/603,852				
					FILING DATE: June 25, 2003				
					EXAMINER: Ow	ens, Dougl	as W.		
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EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME		CLASS	SUB CLASS	FILING DATE IF APPROPRIATE	
0)40	A208	6,515,335 B1	02/04/2003	Christiansen et al.			1		
1	A209	6,524,935	02/25/2003	Canaperi	et al.				
	A210	6,534,381 B2	03/18/2003	Cheung et al.			 		
-	A211	6,555,839	04/29/2003	Fitzgerald					
	A212	6,583,437 B2	06/24/2003	Mizuno et al.					
	A213	6,593,191	07/15/2003	Fitzgerald		<u> </u>		01/17/2001	
	A214	6,593,625 B2	07/15/2003	Christiansen et al.				04/03/2002	
	A215	6,596,610 B1	07/22/2003	Kuwabar	a et al.			11/27/2000	
	A216	6,602,613	08/05/2003	Fitzgeral	d			05/16/2000	
	A217	6,603,156	08/05/2003	Rim				03/31/2001	
	A218	6,607,948 B1	08/19/2003	Sugiyam	a et al.			08/24/2001	
	A219	6,624,047 B1	09/23/2003	Sakaguci	ni et al.			02/01/2000	
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240	B38	01/93338	12/06/2001	WO				N		Y	
2040	B39	02/13262	02/14/2002	wo				N		Y	
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040	B42	02/47168	06/13/2002	WO				N		Y	
040	B43	02/071488	09/12/2002	wo				N		Y	
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240	B48	04/006326	01/15/2004	wo				N		Y	
240	B49	04/006327	01/15/2004	wo				N		Y	
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C/10 C92	Herzog et al., (December 12,	"SiGe-based F , 2000), pp. 36	ETs: Buffer Is -41.	sues and Devi	ice Resul	ts," <u>Thin Sol</u>	<u>id Films,</u> V					
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ONO	C113	Leitz et al., "C Research Socie							SFETs	," <u>Material</u>				
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